

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1067MHz capability for CPU at 2.66, 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Table(Bios) | Voltage | DIMM socket support (Optional) | | |
|-----------|----------------------|--------|-------|------------|---------------------|--------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| CORSAIR | CM3X1024-1066C7 | 1024MB | DS | N/A | Heat-Sink Package | 7 | 1.1 | * | * | * |
| Crucial | CT12864BA1067.8FF | 1024MB | SS | MICRON | D9KPT | 7(1066-7-7-7-20) | | * | * | * |
| Crucial | CT12864BA1067.8SFD | 1024MB | SS | MICRON | D9JNL | 7 | | * | * | * |
| Crucial | CT12872BA1067.9FF | 1024MB | SS | MICRON | D9KPT(ECC) | 7(1066-9-9-9-25) | | * | * | * |
| Crucial | CT25664BA1067.16FF | 2048MB | DS | MICRON | D9KPT | 7(1066-7-7-7-20) | | * | * | * |
| Crucial | CT25664BA1067.16SFD | 2048MB | DS | MICRON | D9JNL | 7 | | * | * | * |
| Crucial | CT25672BA1067.18FF | 2048MB | DS | MICRON | D9KPT(ECC) | 7(1066-7-7-7-20) | | * | * | * |
| ELPIDA | EBJ10UE8BAW0-AE-E | 1024MB | SS | ELPIDA | J1108BABG-DJ-E | 7(1066-7-7-7-20) | | * | * | * |
| ELPIDA | EBJ11RD8BAFA-AE-E | 1024MB | DS | ELPIDA | J5308BASE-AC-E(ECC) | 7 | | * | * | * |
| ELPIDA | EBJ11UD8BAFA-AG-E | 1024MB | DS | ELPIDA | J5308BASE-AC-E | 8 | | * | * | * |
| ELPIDA | EBJ21UE8BAW0-AE-E | 2048MB | DS | ELPIDA | J1108BABG-DJ-E | 7(1066-7-7-7-20) | | * | * | * |
| Hynix | HMT112U6AFP8C-G7N0 | 1024MB | SS | HYNIX | H5TQ1G83AFP7C | 7 | | * | * | * |
| Hynix | HYMT112U64ZNF8-G7 | 1024MB | SS | HYNIX | HY5TQ1G831ZNFP-G7 | 7 | | * | * | * |
| Hynix | HMT125U6AFP8C-G7N0 | 2048MB | DS | HYNIX | H5TQ1G83AFP7C | 7 | | * | * | * |
| Hynix | HYMT125U64ZNF8-G7 | 2048MB | DS | HYNIX | HY5TQ1G831ZNFP-G7 | 7 | | * | * | * |
| KINGSTON | KVR1066D3N7/1G | 1024MB | SS | ELPIDA | J1108BABG-DJ-E | 1066-7-7-7-20 | 1.5 | * | * | * |
| KINGSTON | KVR1066D3N7/2G | 2048MB | DS | ELPIDA | J1108BABG-DJ-E | 1066-7-7-7-20 | 1.5 | * | * | * |
| KINGSTON | KVR1066D3N7/4G | 4096MB | DS | SAMSUNG | K4B2G0846B-HCF8 | 1066-7-7-7-20 | 1.5 | * | * | * |
| MICRON | MT8JTF12864AY-1G1D1 | 1024MB | SS | MICRON | 7VD22 | 7 | | * | * | * |
| MICRON | MT8JTF12864AZ-1G1F1 | 1024MB | SS | MICRON | 8ZF22 D9KPV | 7(1066-7-7-7-20) | | * | * | * |
| MICRON | MT8JTF12864AZ-1G1F1 | 1024MB | SS | MICRON | D9KPT | 7(1066-7-7-7-20) | | * | * | * |
| MICRON | MT9JSF12872AZ-1G1F1 | 1024MB | SS | MICRON | D9KPT(ECC) | 7(1066-9-9-9-25) | | * | * | * |
| MICRON | MT16JTF25664AY-1G1D1 | 2048MB | DS | MICRON | 7VD22 | 7 | | * | * | * |
| MICRON | MT16JTF25664AZ-1G1F1 | 2048MB | DS | MICRON | 8ZF22 D9KPV | 7(1066-7-7-7-20) | | * | * | * |
| MICRON | MT16JTF25664AZ-1G1F1 | 2048MB | DS | MICRON | D9KPT | 7(1066-7-7-7-20) | | * | * | * |
| MICRON | MT18JSF25672AZ-1G1F1 | 2048MB | DS | MICRON | D9KPT(ECC) | 7(1066-7-7-7-20) | | * | * | * |
| SAMSUNG | M37B5273BH1-CF8 | 4096MB | DS | SAMSUNG | K4B2G0846B-HCF8 | 8(7-7-7-20) | 1.5 | * | * | * |
| Transcend | TS256MLK64V1U | 2048MB | DS | ELPIDA | J1108BABG-AE-E | 7(1066-7-7-7-20) | | * | * | * |
| Asint | SLY3128M8-EAE | 1024MB | SS | Asint | DDRIII1208-AE | (7-7-7-20) | | * | * | * |
| Asint | SLZ3128M8-EAE | 2048MB | DS | Asint | DDRIII1208-AE | (7-7-7-20) | | * | * | * |
| WINTEC | 3DU3191A-10 | 1024MB | DS | Qimonda | IDSH51-03A1F1C-10F | 7 | | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1333MHz capability for CPU at 2.66, 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|---------|-------------------------------------------------------|------------------|-------|------------|---------------------|-------------------------|-----------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| A-DATA | AD13301GOU | 1024MB | SS | A-DATA | AD30908C8D-15IG | 1333-9-9-9-24 | | * | * | * |
| A-DATA | AD1333002GOU | 2048MB | DS | A-DATA | AD30908C8D-15IG | 1333-9-9-9-24 | | * | * | * |
| A-DATA | AD31333E002GOU | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 7-7-7-20(1333-9-9-9-24) | 1.65-1.85 | * | * | * |
| Apacer | 78.01GC6.420 | 1024MB | SS | ELPIDA | J1108BABG-DJ-E | (1333-9-9-9-24) | | * | * | * |
| Apacer | 78.01GC6.9L0 | 1024MB | SS | Apacer | AM5D5808AEWSBG | 9(1333-9-9-9-24) | | * | * | * |
| Apacer | 78.01GC8.422 | 1024MB | SS | ELPIDA | J1108BABG-DJ-E(ECC) | (1333-9-9-9-24) | | * | * | * |
| Apacer | 78.A1GC6.421 | 2048MB | DS | ELPIDA | J1108BABG-DJ-E | (1333-9-9-9-24) | | * | * | * |
| Apacer | 78.A1GC6.9L1 | 2048MB | DS | Apacer | AM5D5808AEWSBG | 9(1333-9-9-9-24) | | * | * | * |
| Apacer | 78.A1GC8.423 | 2048MB | DS | ELPIDA | J1108BABG-DJ-E(ECC) | (1333-9-9-9-24) | | * | * | * |
| CORSAIR | TR3X3G1333C9 (Ver2.1) | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-24(1333-9-9-9-24) | 1.5 | * | * | * |
| CORSAIR | CM3X1024-1333C9DHX | 1024MB | DS | N/A | Heat-Sink Package | (1333-9-9-9-24) | 1.1 | * | * | * |
| CORSAIR | Box/P/N: TWIN3X2048-1333C9 (CM3X1024-1333C9)Ver1.1 | 2048MB(Kit of 2) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.70 | * | * | * |
| CORSAIR | Box/P/N: TWIN3X4G1333C9DHX (CM3X2048-1333C9DHX)Ver3.2 | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.70 | * | * | * |
| CORSAIR | TR3X6G1333C9 (Ver2.1) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1333-9-9-9-24) | 1.5 | * | * | * |
| Crucial | CT12864BA1339.8FF | 1024MB | SS | MICRON | D9KPT | 9(1333-9-9-9-24) | | * | * | * |
| Crucial | CT12864BA1339.8SFD | 1024MB | SS | MICRON | MT8JF12864AY-1G4D1 | (1333-9-9-9-24) | | * | * | * |
| Crucial | CT12872BA1339.9FF | 1024MB | SS | MICRON | D9KPT(ECC) | 9(1333-9-9-9-24) | | * | * | * |
| Crucial | CT25664BA1339.16FF | 2048MB | DS | MICRON | D9KPT | 9(1333-9-9-9-24) | | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1333MHz capability for CPU at 2.66, 2.8 and 2.93GHz (continued)

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|---------------|-------------------------|------------------|-------|------------|-------------------|-------------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| Crucial | CT25672BA1339.18FF | 2048MB | DS | MICRON | D9KPT(ECC) | 9(1333-9-9-9-24) | | * | * | * |
| Crucial | BL25664BA1336.16SFB1 | 4096MB(Kit of 2) | DS | NA | Heat-Sink Package | 6-6-6-20(1333-9-9-9-24) | 1.8 | * | * | * |
| ELPIDA | EBJ10UE8BAW0-DJ-E | 1024MB | SS | ELPIDA | J1108BABG-DJ-E | 9(1333-9-9-9-24) | | * | * | * |
| ELPIDA | EBJ21UE8BAW0-DJ-E | 2048MB | DS | ELPIDA | J1108BABG-DJ-E | 9(1333-9-9-9-24) | | * | * | * |
| G.SKILL | F3-10600CL7D-2GBPI | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | (1337-7-7-7-18) | 1.65 | * | * | * |
| G.SKILL | F3-10600CL8D-2GBHK | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | (1337-8-8-8-22) | 1.65 | * | * | * |
| G.SKILL | F3-10666CL7T-6GBPK(XMP) | 2048MB | DS | N/A | Heat-Sink Package | 7-7-7-18(1333-7-7-7-18) | 1.5-1.6 | * | * | * |
| G.SKILL | F3-10666CL8D-4GBHK(XMP) | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 8-8-8-21(1333-7-7-7-20) | 1.5-1.6 | * | * | * |
| G.SKILL | F3-10666CL9T-6GBNQ | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1333-9-9-9-24) | 1.5 | * | * | * |
| GEIL | GV34GB1333C7DC | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-24(1333-8-8-8-28) | 1.5 | * | * | * |
| Hynix | HMT112U6BFR8C-H9 | 1024MB | SS | Hynix | H5TQ1G83BFR | 9(1333-9-9-9-24) | | * | * | * |
| Hynix | HMT125U6BFR8C-H9 | 2048MB | DS | Hynix | H5TQ1G83BFR | 9(1333-9-9-9-24) | | * | * | * |
| Hynix | HMT125U6BFR8C-H9 | 2048MB | DS | Hynix | H5TQ1G83BFRH9C | 9(1333-9-9-9-24) | | * | * | * |
| KINGMAX | FLFD45F-B8E9 | 1024MB | SS | ELPIDA | J1108BASE-DJ-E | (1333-9-9-9-24) | | * | * | * |
| KINGSTON | KVR1333D3N9/1G | 1024MB | SS | ELPIDA | J1108BABG-DJ-E | 9(1066-8-7-7-20) | 1.5 | * | * | * |
| KINGSTON | KVR1333D3N9/2G | 2048MB | DS | ELPIDA | J1108BABG-DJ-E | 1333-9-9-9-24 | 1.5 | * | * | * |
| KINGSTON | KVR1333D3N9/2G | 2048MB | DS | ELPIDA | J1108BABG-DJ-E | 9(1066-8-7-7-20) | 1.5 | * | * | * |
| MICRON | MT8JTF12864AY-1G4BYTES | 1024MB | SS | MICRON | Z9HWR | (1333-9-9-9-24) | | * | * | * |
| MICRON | MT8JTF12864AZ-1G4F1 | 1024MB | SS | MICRON | 9FF22 D9KPT | 9(1066-8-8-8-20) | | * | * | * |
| MICRON | MT8JTF12864AZ-1G4F1 | 1024MB | SS | MICRON | D9KPT | 9(1333-9-9-9-24) | | * | * | * |
| MICRON | MT9JSF12872AZ-1G4F1 | 1024MB | SS | MICRON | D9KPT(ECC) | 9(1333-9-9-9-24) | | * | * | * |
| MICRON | MT16JF25664AZ-1G4F1 | 2048MB | DS | MICRON | D9KPT | 9(1333-9-9-9-24) | | * | * | * |
| MICRON | MT16JTF25664AZ-1G4F1 | 2048MB | DS | MICRON | 9FF22 D9KPT | 9(1066-8-8-8-20) | | * | * | * |
| MICRON | MT18JSF25672AZ-1G4F1 | 2048MB | DS | MICRON | D9KPT(ECC) | 9(1333-9-9-9-24) | | * | * | * |
| OCZ | OC23RPX1333EB2GK | 1024MB | SS | N/A | Heat-Sink Package | (1066-6-5-5-20) | | * | * | * |
| OCZ | OC23G1333LV3GK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9(1066-7-7-7-20) | 1.65 | * | * | * |
| OCZ | OC23P1333LV3GK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 7-7-7(1066-7-7-7-16) | 1.65 | * | * | * |
| OCZ | OC23P13332GK | 1024MB | DS | N/A | Heat-Sink Package | 7-7-7-20(1333-9-9-9-24) | | * | * | * |
| OCZ | OC23P13334GK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7(1333-7-7-7-20) | 1.8 | * | * | * |
| OCZ | OC23G1333LV6GK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9(1066-7-7-7-20) | 1.65 | * | * | * |
| OCZ | OC23P1333LV6GK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 7-7-7(1066-7-7-7-20) | 1.65 | * | * | * |
| OCZ | OC2X1333LV6GK(XMP) | 6144MB(Kit of 3) | DS | NA | Heat-Sink Package | 8-8-8(1066-7-7-7-16) | 1.6 | * | * | * |
| SAMSUNG | M378B2873DZ1-CH9 | 1024MB | SS | SAMSUNG | K4B1G0846D | 9(1333-9-9-9-24) | | * | * | * |
| SAMSUNG | M378B2873EH1-CH9 | 1024MB | SS | SAMSUNG | K4B1G0846E | 1066-8-7-7-20 | | * | * | * |
| SAMSUNG | M391B2873DZ1-CH9 | 1024MB | SS | SAMSUNG | K4B1G0846D(ECC) | 9(1333-9-9-9-24) | | * | * | * |
| SAMSUNG | M378B5673DZ1-CH9 | 2048MB | DS | SAMSUNG | K4B1G0846D | 9(1333-9-9-9-24) | | * | * | * |
| SAMSUNG | M378B5673EH1-CH9 | 2048MB | DS | SAMSUNG | K4B1G0846E | 1066-8-7-7-20 | | * | * | * |
| SAMSUNG | M391B5673DZ1-CH9 | 2048MB | DS | SAMSUNG | K4B1G0846D(ECC) | 9(1333-9-9-9-24) | | * | * | * |
| SAMSUNG | M378B5273BH1-CH9 | 4096MB | DS | SAMSUNG | K4B2G0846B-HCH9 | 9(1333-9-9-9-24) | | * | * | * |
| Super Talent | W1333UX2GB(XMP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | 8(1333-8-8-8-24) | 1.8 | * | * | * |
| Transcend | TS128MLK64V3U | 1024MB | SS | SAMSUNG | K4B1G0846D | 9(1333-9-9-9-24) | | * | * | * |
| Transcend | TS256MLK64V3U | 2048MB | DS | SAMSUNG | K4B1G0846D | 9(1333-9-9-9-24) | | * | * | * |
| Asint | SLY3128M8-EDJ | 1024MB | SS | Asint | DDRIII1208-DJ | (9-9-9-24) | | * | * | * |
| Asint | SLY3128M8-EDJE | 1024MB | SS | ELPIDA | J1108BASE-DJ-E | 1066-8-8-8-20 | | * | * | * |
| Asint | SLZ3128M8-EDJ | 2048MB | DS | Asint | DDRIII1208-DJ | (9-9-9-24) | | * | * | * |
| Asint | SLZ3128M8-EDJE | 2048MB | DS | ELPIDA | J1108BASE-DJ-E | 1066-8-8-8-20 | | * | * | * |
| ASUS | N/A | 1024MB | DS | N/A | Heat-Sink Package | (1333-9-9-9-24) | | * | * | * |
| BUFFALO | FSX1333D3G-1G | 1024MB | SS | N/A | Heat-Sink Package | (1066-7-7-7-20) | | * | * | * |
| BUFFALO | FSH1333D3G-T3G(XMP) | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 7-7-7-20(1066-8-7-7-20) | | * | * | * |
| BUFFALO | FSX1333D3G-2G | 2048MB | DS | N/A | Heat-Sink Package | (1066-7-7-7-20) | | * | * | * |
| Patriot | PDC32G1333LLK | 1024MB | SS | PATRIOT | Heat-Sink Package | 7(1337-7-7-7-20) | 1.7 | * | * | * |
| Patriot | PVT33G1333ELK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.65 | * | * | * |
| Patriot | PVS34G1333ELK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.5 | * | * | * |
| Patriot | PVS34G1333LLK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20(1066-7-7-7-20) | 1.7 | * | * | * |
| Patriot | PVT36G1333ELK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.65 | * | * | * |
| Silicon Power | SP001GBLTU133S02 | 1024MB | SS | S-POWER | I0YT3E0 | 9(1333-9-9-9-24) | | * | * | * |
| Silicon Power | SP002GBLTU133S02 | 2048MB | DS | S-POWER | I0YT3E0 | 9(1333-9-9-9-24) | | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1600MHz capability for CPU at 2.66GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|------------|---------------------------------------------------|------------------|-------|------------|-------------------|-------------------------|-----------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| A-DATA | AD31600E001GMU | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8-24(1333-9-9-9-24) | 1.65-1.85 | * | * | * |
| A-DATA | AD31600F002GMU(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 7-7-7-20(1333-9-9-9-24) | 1.75-1.85 | * | * | * |
| CORSAIR | TR3X3G1600C8D(XMP)Ver2.1 | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8-24(1601-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X3G1600C8D | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8-24(1600-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X3G1600C9(XMP)Ver1.1 | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-24(1601-9-9-9-24) | 1.65 | * | * | * |
| CORSAIR | BoxPIN:TW3X4G1600C9DHXNV(CM3X2G1600C9DHXNV)Ver4.1 | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | (1333-9-9-9-24) | 1.80 | * | * | * |
| CORSAIR | TR3X6G1600C8D(XMP)Ver2.1 | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-24(1601-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X6G1600C8D | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-24(1600-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X6G1600C9(XMP)Ver2.1 | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1333-9-9-9-24) | 1.65 | * | * | * |
| Crucial | BL12864BA1608.8SFB(XMP) | 1024MB | SS | N/A | Heat-Sink Package | (1601-8-8-8-24) | 1.8 | * | * | * |
| G.SKILL | F3-12800CL9D-2GBNQ | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | (1333-9-9-9-24) | 1.6 | * | * | * |
| G.SKILL | F3-12800CL8T-6GBHK(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-21(1333-8-8-8-21) | 1.6-1.65 | * | * | * |
| G.SKILL | F3-12800CL8T-6GBPI(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-21(1066-8-8-8-20) | 1.6-1.65 | * | * | * |
| G.SKILL | F3-12800CL9T-6GBNQ | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1601-9-9-9-24) | 1.5-1.6 | * | * | * |
| GEIL | GV34GB1600C8DC | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 8-8-8-28(1600-8-8-8-28) | 1.6 | * | * | * |
| KINGMAX | FLGD45F-B8KG9-NAES | 1024MB | SS | KINGMAX | KFB8FNGXF-ANX-12A | 9(1600-9-8-9-28) | 1.5 | * | * | * |
| KINGMAX | FLGE85F-B8KG9-NEES | 2048MB | DS | KINGMAX | KFB8FNGXF-ANX-12A | 9(1600-9-8-9-28) | 1.5 | * | * | * |
| KINGSTON | KHX12800D3LLK3/3GX(XMP) | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 1600-8-8-8-20 | 1.65 | * | * | * |
| KINGSTON | KHX12800D3K2/4G | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 9(1333-9-9-9-24) | 1.9 | * | * | * |
| KINGSTON | KHX12800D3LLK3/6GX(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | (1066-8-8-8-20) | 1.65 | * | * | * |
| OCZ | OCZ3P1600EB1G | 1024MB | SS | N/A | Heat-Sink Package | 7-6-6-24(1333-7-7-7-20) | | * | * | * |
| OCZ | OCZ3G1600LV3GK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8(1066-7-7-7-20) | 1.65 | * | * | * |
| OCZ | OCZ3P1600LV3GK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 7-7-7(1066-7-7-7-20) | 1.65 | * | * | * |
| OCZ | OCZ3P16004GK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7(1333-7-7-7-20) | 1.9 | * | * | * |
| OCZ | OCZ3P1600EB4GK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-6(1333-7-7-7-20) | 1.8 | * | * | * |
| OCZ | OCZ3G1600LV6GK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8(1066-7-7-7-16) | 1.65 | * | * | * |
| OCZ | OCZ3X1600LV6GK(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8(1066-7-7-7-16) | 1.65 | * | * | * |
| Cell Shock | CS322271 | 2048MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-14(1066-7-7-7-20) | 1.7-1.9 | * | * | * |
| Mushkin | 996657 | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20 | | * | * | * |
| Mushkin | 998659(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1333-9-9-9-24) | 1.5-1.6 | * | * | * |
| Patriot | PVT33G1600ELK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.65 | * | * | * |
| Patriot | PVS34G1600ELK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.8 | * | * | * |
| Patriot | PVS34G1600LLK(XMP) | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20(1066-7-7-7-20) | 1.9 | * | * | * |
| Patriot | PVS34G1600LLKN | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20(1066-7-7-7-20) | 2.0 | * | * | * |
| Patriot | PVT36G1600ELK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.65 | * | * | * |
| Patriot | PVT36G1600ELK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1600-7-7-7-20) | 1.65 | * | * | * |
| PQI | MFADR401PA0102(XMP) | 2048MB | DS | SAMSUNG | K4B1G08460 | 1066-8-8-8-20 | | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1600MHz capability for CPU at 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|--------------|---------------------------------------------------|-------------------|-------|------------|-------------------|-------------------------|-----------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| A-DATA | AD31600E001GMU | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8-24(1333-9-9-24) | 1.65-1.85 | * | * | * |
| A-DATA | AD31600F002GMU(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 7-7-7-20(1333-9-9-24) | 1.75-1.85 | * | * | * |
| CORSAIR | TR3X3G1600C8D(XMP)Ver2.1 | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8-24(1601-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X3G1600C8D | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8-24(1600-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X3G1600C9(XMP)Ver1.1 | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-24(1601-9-9-9-24) | 1.65 | * | * | * |
| CORSAIR | BoxP/N:TW3X4G1600C9DHXNV(CM3X2G1600C9DHXNV)Ver4.1 | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | (1333-9-9--9-24) | 1.80 | * | * | * |
| CORSAIR | TR3X6G1600C8D(XMP)Ver2.1 | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-24(1601-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X6G1600C8D | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-24(1600-8-8-8-24) | 1.65 | * | * | * |
| CORSAIR | TR3X6G1600C9(XMP)Ver2.1 | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1333-9-9-24) | 1.65 | * | * | * |
| Crucial | BL12864BA1608.8SFB(XMP) | 1024MB | SS | N/A | Heat-Sink Package | (1601-8-8-8-24) | 1.8 | * | * | * |
| G.SKILL | F3-12800CL9D-2GBNQ | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | (1333-9-9-9-24) | 1.6 | * | * | * |
| G.SKILL | F3-12800CL8T-6GBHK(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-21(1333-8-8-8-21) | 1.6-1.65 | * | * | * |
| G.SKILL | F3-12800CL8T-6GBP(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8-21(1066-8-8-8-20) | 1.6-1.65 | * | * | * |
| G.SKILL | F3-12800CL9T-6GBNQ | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1601-9-9-9-24) | 1.5-1.6 | * | * | * |
| GEIL | GV34GB1600C8DC | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 8-8-8-28(1600-8-8-8-28) | 1.6 | * | * | * |
| KINGMAX | FLGD45F-B8KG9-NAES | 1024MB | SS | KINGMAX | KFB8FNGXF-ANX-12A | 9(1600-9-8-9-28) | 1.5 | * | * | * |
| KINGMAX | FLGE85F-B8KG9-NEES | 2048MB | DS | KINGMAX | KFB8FNGXF-ANX-12A | 9(1600-9-8-9-28) | 1.5 | * | * | * |
| KINGSTON | KHX12800D3LK3/3GX(XMP) | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 1600-8-8-8-20 | 1.65 | * | * | * |
| KINGSTON | KHX12800D3K3/12GX(XMP) | 12288MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9(1066-9-9-9-24) | | * | * | * |
| KINGSTON | KHX12800D3K2/4G | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 9(1333-9-9-9-24) | 1.9 | * | * | * |
| KINGSTON | KHX12800D3LK3/6GX(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | (1066-8-8-8-20) | 1.65 | * | * | * |
| OCZ | OCZ3P1600EB1G | 1024MB | SS | N/A | Heat-Sink Package | 7-6-6-24(1333-7-7-7-20) | | * | * | * |
| OCZ | OCZ3G1600LV3GK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 8-8-8(1066-7-7-7-20) | 1.65 | * | * | * |
| OCZ | OCZ3P1600LV3GK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 7-7-7(1066-7-7-7-20) | 1.65 | * | * | * |
| OCZ | OCZ3P16004GK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7(1333-7-7-7-20) | 1.9 | * | * | * |
| OCZ | OCZ3P1600EB4GK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-6(1333-7-7-7-20) | 1.8 | * | * | * |
| OCZ | OCZ3X16004GK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20 | 1.9 | * | * | * |
| OCZ | OCZ3G1600LV6GK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8(1066-7-7-7-16) | 1.65 | * | * | * |
| OCZ | OCZ3X1600LV6GK(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8(1600-8-8-8-24) | 1.65 | * | * | * |
| OCZ | OCZ3X1600LV6GK(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 8-8-8(1066-7-7-7-16) | 1.65 | * | * | * |
| Super Talent | WB160UX6GB(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 1333-8-8-8-24 | | * | * | * |
| Cell Shock | CS322271 | 2048MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-14(1066-7-7-7-20) | 1.7-1.9 | * | * | * |
| Mushkin | 996657 | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20 | | * | * | * |
| Mushkin | 998659(XMP) | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1333-9-9-9-24) | 1.5-1.6 | * | * | * |
| Patriot | PVT33G1600ELK | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.65 | * | * | * |
| Patriot | PVS34G1600ELK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.8 | * | * | * |
| Patriot | PVS34G1600LLK(XMP) | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20(1066-7-7-7-20) | 1.9 | * | * | * |
| Patriot | PVS34G1600LLKN | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 7-7-7-20(1066-7-7-7-20) | 2.0 | * | * | * |
| Patriot | PVT36G1600ELK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 1.65 | * | * | * |
| Patriot | PVT36G1600ELK | 6144MB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1600-7-7-7-20) | 1.65 | * | * | * |
| PQI | MFADR401PA0102(XMP) | 2048MB | DS | SAMSUNG | K4B1G08460 | 1066-8-8-8-20 | | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1625MHz capability for CPU at 2.66GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|----------|-------------------------|------------------|-------|------------|-------------------|-------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| KINGSTON | KHX13000D3LLK2/2GN(EPP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | * |
| KINGSTON | KHX13000D3LLK2/2GX(XMP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | * |
| KINGSTON | KHX13000D3LLK2/2GXN | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1625MHz capability for CPU at 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Table(Bios) | Voltage | DIMM socket support (Optional) | | |
|----------|-------------------------|------------------|-------|------------|-------------------|--------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| KINGSTON | KHX13000D3LLK2/2GN(EPP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | * |
| KINGSTON | KHX13000D3LLK2/2GX(XMP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | * |
| KINGSTON | KHX13000D3LLK2/2GXN | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1800MHz capability for CPU at 2.66GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|-----------|--------------------------------------------|---------------|-------|------------|-------------------|-------------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| Apacer | 78.0AGCD-CDZ(XMP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8-8-8-24(1800-8-8-8-24) | 1.8 | * | * | |
| CORSAIR | BoxP/N:TW3X4G1800C8DF(CM3X2G1800C8D)Ver4.1 | 4GB(Kit of 2) | DS | N/A | Heat-Sink Package | 8-8-8-24 | 1.80 | * | * | |
| KINGSTON | KHX14400D3/1G | 1GB | SS | N/A | Heat-Sink Package | | 1.9 | * | * | |
| KINGSTON | KHX14400D3K2/2GN(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | * |
| KINGSTON | KHX14400D3K3/3GX(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 1800-9-9-9-27 | 1.65 | * | * | |
| OCZ | OCZ3P18002GK | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8 | | * | * | |
| OCZ | OCZ3P18004GK | 4GB(Kit of 2) | DS | N/A | Heat-Sink Package | 8 | 1.9 | * | * | |
| Transcend | TX1800KLU-2GK(XMP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8 | | * | * | * |
| Patriot | PVS32G1800LLKN(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8-8-8-20(1066-7-7-7-20) | 1.9 | * | * | |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1800MHz capability for CPU at 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|-----------|--------------------------------------------|------------------|-------|------------|-------------------|-------------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| Apacer | 78.0AGCD-CDZ(XMP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | 8-8-8-24(1800-8-8-8-24) | 1.8 | * | * | |
| CORSAIR | BoxP/N:TW3X4G1800C8DF(CM3X2G1800C8D)Ver4.1 | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 8-8-8-24 | 1.80 | * | * | |
| KINGSTON | KHX14400D3/1G | 1024MB | SS | N/A | Heat-Sink Package | | 1.9 | * | * | |
| KINGSTON | KHX14400D3K2/2GN(EPP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | | 1.9 | * | * | |
| KINGSTON | KHX14400D3K3/3GX(XMP) | 3072MB(Kit of 3) | SS | N/A | Heat-Sink Package | 1800-9-9-9-27 | 1.65 | * | * | |
| OCZ | OCZ3P18002GK | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | 8 | | * | * | |
| OCZ | OCZ3P18004GK | 4096MB(Kit of 2) | DS | N/A | Heat-Sink Package | 8 | 1.9 | * | * | |
| Transcend | TX1800KLU-2GK(XMP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | 8 | | * | * | |
| Patriot | PVS32G1800LLKN(EPP) | 2048MB(Kit of 2) | SS | N/A | Heat-Sink Package | 8-8-8-20(1066-7-7-7-20) | 1.9 | | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1866MHz capability for CPU at 2.66GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|----------|---------------------------|---------------|-------|------------|-------------------|-------------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| Apacer | 78.0AGCQ.CBZ(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-27(1066-8-8-8-20) | | * | | |
| Crucial | BL12864BE2009.8SFB3(EPP) | 1GB | SS | N/A | Heat-Sink Package | 9-9-9-28(1333-9-9-9-24) | 2 | * | * | * |
| G.SKILL | F3-16000CL7T-6GBPS(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 7-8-7-20(1066-8-8-8-20) | 1.65 | * | * | |
| G.SKILL | F3-16000CL9T-6GBPS(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-8-8-8-20) | 1.65 | * | * | |
| KINGSTON | KHX16000D3K2/2GN(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | | 2.0 | * | * | * |
| KINGSTON | KHX16000D3K3/3GX(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9(1333-9-9-9-24) | 1.65 | * | * | * |
| KINGSTON | KHX16000D3ULT1K3/6GX(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 8(1066-8-8-8-20) | 1.65 | * | * | * |
| KINGSTON | KHX16000D3T1K3/6GX(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9(1066-8-8-8-20) | 1.65 | * | * | * |
| OCZ | OCZ3FXT20002GK | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8 | 1.9 | * | * | * |
| OCZ | OCZ3P20002GK(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 9 | 1.9 | * | * | * |
| OCZ | OCZ3P2000EB2GK | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 9-8-8(1066-8-7-7-20) | 1.8 | * | * | * |
| Giggle | 9CAA537AZZ01D1 | 2BG | DS | N/A | Heat-Sink Package | 9-9-9-24 | | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-1866MHz capability for CPU at 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|--------------|-----------------------|---------------|-------|------------|-------------------|-------------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| CORSAIR | TR3X3G1866C9D(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-24(1866-9-9-9-24) | 1.65 | * | * | |
| CORSAIR | TR3X6G1866C9D | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1866-9-9-9-24) | 1.65 | * | * | * |
| KINGSTON | KHX14900D3K3/3GX(XMP) | 3GB | SS | N/A | Heat-Sink Package | 9(1333-9-9-9-24) | 1.65 | * | * | |
| OCZ | OCZ3RPR1866C9LV3GK | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9(1066-7-7-7-20) | 1.65 | * | * | |
| OCZ | OCZ3RPR1866C9LV6GK | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9(1066-7-7-7-20) | 1.65 | * | * | * |
| Super Talent | W1866UX2GB(XMP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8-8-8-24(1333-9-9-9-24) | | * | * | * |
| Patriot | PVS32G1866LLK(XMP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8-8-8-24(1066-7-7-7-20) | 1.9 | | * | |
| Patriot | PVS32G1866LLK(XMP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8-8-8-24(1866-8-8-8-24) | 1.9 | * | * | |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-2000MHz capability for CPU at 2.66GHz

| Vendor | Part No. | Size | SS/DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|----------|---------------------------|---------------|-------|------------|-------------------|-------------------------|---------|--------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| Apacer | 78.0AGCQ.CBZ(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-27(1066-8-8-8-20) | | * | | |
| Crucial | BL12864BE2009.8SFB3(EPP) | 1GB | SS | N/A | Heat-Sink Package | 9-9-9-28(1333-9-9-9-24) | 2 | * | * | * |
| G.SKILL | F3-16000CL7T-6GBPS(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 7-8-7-20(1066-8-8-8-20) | 1.65 | * | * | |
| G.SKILL | F3-16000CL9T-6GBPS(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-8-8-8-20) | 1.65 | * | * | |
| KINGSTON | KHX16000D3K2/2GN(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | | 2.0 | * | * | * |
| KINGSTON | KHX16000D3K3/3GX(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9(1333-9-9-9-24) | 1.65 | * | * | * |
| KINGSTON | KHX16000D3ULT1K3/6GX(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 8(1066-8-8-8-20) | 1.65 | * | * | * |
| KINGSTON | KHX16000D3T1K3/6GX(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9(1066-8-8-8-20) | 1.65 | * | * | * |
| OCZ | OCZ3FXT20002GK | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8 | 1.9 | * | * | * |
| OCZ | OCZ3P20002GK(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 9 | 1.9 | * | * | * |
| OCZ | OCZ3P2000EB2GK | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 9-8-8(1066-8-7-7-20) | 1.8 | * | * | * |
| Giggle | 9CAA537AZZ01D1 | 2GB | DS | N/A | Heat-Sink Package | 9-9-9-24 | | * | * | * |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-2000MHz capability for CPU at 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/ DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|----------|---------------------------|---------------|-----------|---------------|-------------------|-------------------------|---------|--------------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| Apacer | 78.0AGCQ.CBZ(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9-9-9-27(1066-8-8-8-20) | | * | * | |
| Crucial | BL12864BE2009.8SFB3(EPP) | 1GB | SS | N/A | Heat-Sink Package | 9-9-9-28(1333-9-9-9-24) | 2 | * | * | * |
| G.SKILL | F3-16000CL7T-6GBPS(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 7-8-7-20(1066-8-8-8-20) | 1.65 | * | * | |
| G.SKILL | F3-16000CL9T-6GBPS(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-8-8-8-20) | 1.65 | * | * | |
| KINGSTON | KHX16000D3K2/2GN(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | | 2.0 | * | * | * |
| KINGSTON | KHX16000D3K3/3GX(XMP) | 3GB(Kit of 3) | SS | N/A | Heat-Sink Package | 9(1333-9-9-9-24) | 1.65 | * | * | * |
| KINGSTON | KHX16000D3ULT1K3/6GX(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 8(1066-8-8-8-20) | 1.65 | * | * | * |
| KINGSTON | KHX16000D3T1K3/6GX(XMP) | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9(1066-8-8-8-20) | 1.65 | * | * | * |
| OCZ | OCZ3FXT20002GK | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 8 | 1.9 | * | * | |
| OCZ | OCZ3P20002GK(EPP) | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 9 | 1.9 | * | * | |
| OCZ | OCZ3P2000EB2GK | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 9-8-8(1066-8-7-7-20) | 1.8 | * | * | * |
| Gingie | 9CAASS37AZZ01D1 | 2GB | DS | N/A | Heat-Sink Package | 9-9-9-24 | | * | * | * |
| Patriot | PVS32G2000LLKN | 2GB(Kit of 2) | SS | N/A | Heat-Sink Package | 9-9-9-24(1066-7-7-7-20) | 2 | * | * | |

P7P55D-E PRO Motherboard Qualified Vendors Lists (QVL) DDR3-2133MHz capability for CPU at 2.8 and 2.93GHz

| Vendor | Part No. | Size | SS/ DS | Chip Brand | Chip NO. | Timing Dimm(Bios) | Voltage | DIMM socket support (Optional) | | |
|---------|--------------------|---------------|-----------|---------------|-------------------|-------------------------|---------|-----------------------------------|----|----|
| | | | | | | | | A* | B* | C* |
| G.SKILL | F3-17066CL9T-6GB-T | 6GB(Kit of 3) | DS | N/A | Heat-Sink Package | 9-9-9-24(1066-8-7-7-20) | 1.65 | * | * | |



Side(s): SS - Single-sided DS - Double-sided

DIMM support:

- **A*:** Supports one (1) module inserted into slot A1 or B1 as Single-channel memory configuration.
- **B*:** Supports two (2) modules inserted into the blue slots (A1 and B1) as one pair of Dual-channel memory configuration.
- **C*:** Supports four (4) modules inserted into both the blue and the black slots as two pairs of Dual-channel memory configuration.



- ASUS exclusively provides hyper DIMM support function.
- Hyper DIMM support is subject to the physical characteristics of individual CPUs.
- According to Intel spec definition, DDR3-1600 is supported for one DIMM per channel only. ASUS exclusively provides two DDR3-1600 DIMM support for each memory channel.
- According to Intel CPU spec, CPUs with a core frequency of 2.66G support the maximum DIMM frequency of up to DDR3-1333. To use DIMMs of a higher frequency with a 2.66G CPU, enable the **DRAM O.C. Profile** feature in BIOS. Refer to section **3.5.2. Ai Overclock Tuner** for details.
- Visit the ASUS website for the latest QVL.